



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

**In re application of:** Basceri et al.

**Application No.** 09/965,509

**Filed:** September 26, 2001

**Confirmation No.** 3307

**For:** METHODS FOR FORMING AND  
INTEGRATED CIRCUIT STRUCTURES  
CONTAINING ENHANCED-SURFACE-  
AREA CONDUCTIVE LAYERS

**Examiner:** Toniae M. Thomas

**Art Unit:** 2822

**Attorney Reference No.** 6047-59403

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Attorney for Applicant(s) Marie

Date Mailed November 12, 2003

**RESPONSE**

This responds to the Office action dated May 28, 2003. Please amend the referenced application as follows:

**Amendments to the Claims** are reflected in the listing of claims, which begins on page 2.

**Remarks** begin on page 6.

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